

### 2.0x1.25mm SMD CHIP LED LAMP

Part Number: KPHCM-2012SURCK Hyper Red

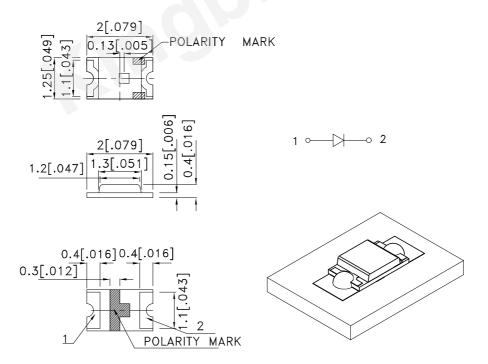
#### **Features**

- 2.0X1.25mm SMT LED,0.5mm max. thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

#### **Description**

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

### **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.





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#### **Selection Guide**

| Part No.        | Dice                | Lens Type   | lv (mcd) [2]<br>@ 20mA |      | Viewing<br>Angle [1] |
|-----------------|---------------------|-------------|------------------------|------|----------------------|
|                 |                     | 2.          | Min.                   | Тур. | 201/2                |
| KPHCM-2012SURCK | Hyper Red (AlGaInP) | Water Clear | 120                    | 230  | 110°                 |
|                 |                     |             | *40                    | *80  |                      |

#### Notes:

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity/ luminous Flux: +/-15%.

  \* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

#### Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter                | Device    | Тур. | Max. | Units | Test Conditions    |
|--------|--------------------------|-----------|------|------|-------|--------------------|
| λpeak  | Peak Wavelength          | Hyper Red | 645  |      | nm    | IF=20mA            |
| λD [1] | Dominant Wavelength      | Hyper Red | 630  |      | nm    | IF=20mA            |
| Δλ1/2  | Spectral Line Half-width | Hyper Red | 28   |      | nm    | IF=20mA            |
| С      | Capacitance              | Hyper Red | 35   |      | pF    | VF=0V;f=1MHz       |
| VF [2] | Forward Voltage          | Hyper Red | 1.95 | 2.5  | V     | IF=20mA            |
| lr     | Reverse Current          | Hyper Red |      | 10   | uA    | V <sub>R</sub> =5V |

#### Notes:

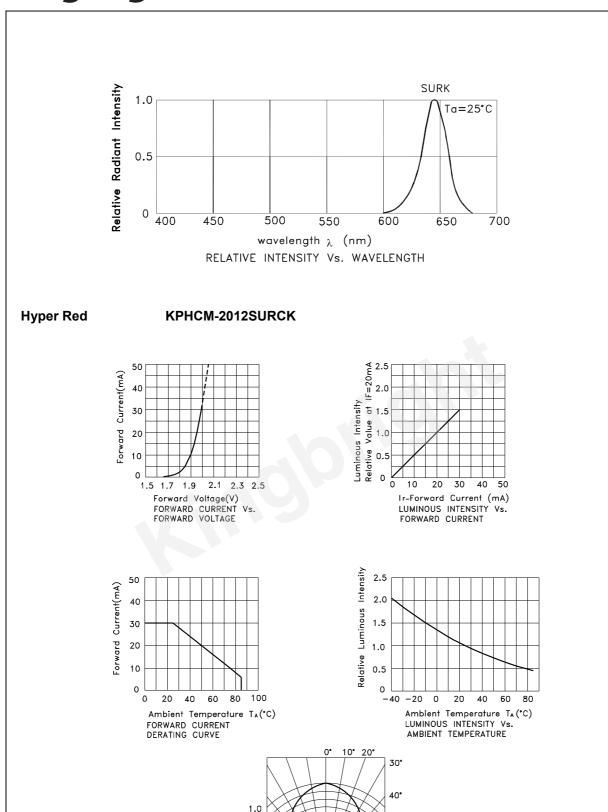
- 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

#### Absolute Maximum Ratings at TA=25°C

| Absolute maximum Natings at 1A 20 0 |                |                |  |  |  |
|-------------------------------------|----------------|----------------|--|--|--|
| Parameter                           | Hyper Red      | Units          |  |  |  |
| Power dissipation                   | 75             | mW             |  |  |  |
| DC Forward Current                  | 30             | mA             |  |  |  |
| Peak Forward Current [1]            | 185            | mA             |  |  |  |
| Reverse Voltage                     | 5              | V              |  |  |  |
| Operating Temperature               | -40°C To +85°C | -40°C To +85°C |  |  |  |
| Storage Temperature                 | -40°C To +85°C | -40°C To +85°C |  |  |  |

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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SPATIAL DISTRIBUTION

0.7

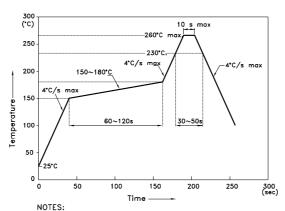
50° 60° 70° 80°

90°

#### **KPHCM-2012SURCK**

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



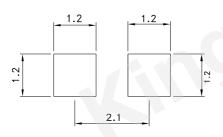
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

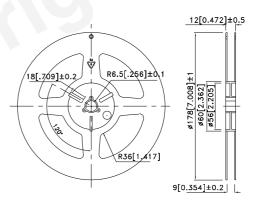
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

  3.Number of reflow process shall be 2 times or less.

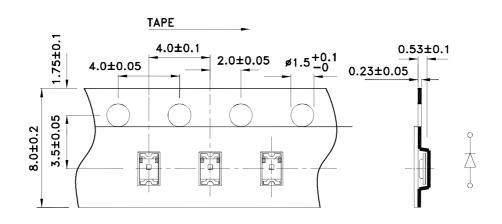
**Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)



### **Reel Dimension**



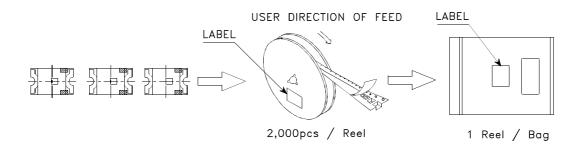
**Tape Dimensions** (Units: mm)

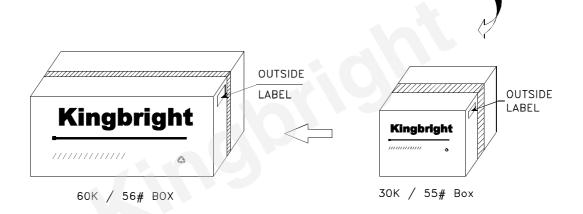


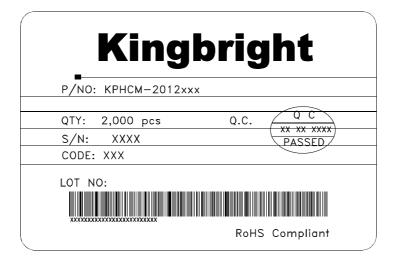
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#### **PACKING & LABEL SPECIFICATIONS**

#### **KPHCM-2012SURCK**







Detailed application notes are listed on our website. <a href="http://www.kingbright.com/application">http://www.kingbright.com/application</a> notes

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